Ref #	Hits	Search Query	DBs	Default Operator	Plurais	Time Stamp
L1	6529	((si or silicon) and (ni or nickel)) near (braze or braz\$4 or solder or solder\$4 or plate or plated or plating or electroplate or electroplated or electroplating or coat or coat\$4 or layer or film)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 11:12
L2	4363	1 and ((press or press\$4) and (heat or heat\$4) or diffusion near bond\$4 or solder or solder\$4 or braze or braz\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 11:58
L3	4363	2 and (((press or press\$4) and (heat or heat\$4)) or diffusion near bond\$4 or solder or solder\$4 or braze or braz\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 11:58
L4	1311	3 and (((press or press\$4) and (heat or heat\$4)) or diffusion near bond\$4 or solder or solder\$4 or braze or braz\$4 or bond or bond\$4 or attach or attach\$5 or join or join\$4) near (substrate or member or sheet or plate or work or workpiece or work near piece)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:01
L5	74	4 and (resonator or resonat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:05
L6	48	5 and mirror	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:06
L7	8	6 and bragg	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:34

L9	16	(6 or 7) and (hermetic or hermetically or hermetic\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:47
L10	13	9 not 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:37
L11	27	6 not (7 or 9)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:40
L12	26	5 not (6 or 7 or 9)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:43
L13	1237	4 not (5 or 6 or 7 or 9)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/02/23 12:43
L14	1016	13 and (si or silicon or ni or nickel or cover or cover\$4 or coat or coat\$4 or layer or film or solder or braze or solder\$4 or braz\$4 or plate or plated or plating or electroplate or electroplated or electroplating) near (thick or thick\$5 or mm or millimeter or inch or microinch or inch\$3 or microinch\$3 or micron or micrometer or ".mu.m")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR <sub>.</sub>	ON	2006/02/23 12:45
L15	114	14 and (hermetic or hermetically or hermetic\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:47

L16	0	15 and (nisi or ni adj si)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:48
L17	25	14 and (nisi or ni adj si)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:49
L18	30	13 and (nisi or ni adj si)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 12:49

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	18442	((228/122.1,123.1,124.6,262.1, 262.2,262.21) or (438/106-112, 119,127,406,584,612-615,652, 660,661,674,761,762)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/23 08:34
L2	6902	1 and (press or press\$4 or force or load) and (heat or heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:42
L3	134	2 and ((si or silicon) and (ni or nickel)) near (cover or cover\$4 or coat or coat\$4 or layer or film)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:36
L4	5	3 and ((si or silicon) near (ni or nickel)) near (cover or cover\$4 or coat or coat\$4 or layer or film)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:44
L5	111	3 and (si or silicon or ni or nickel or cover or cover\$4 or coat or coat\$4 or layer or film) near (thick or thick\$5 or mm or millimeter or inch or microinch or inch\$3 or microinch\$3 or micron or micrometer or ".mu.m")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:44
L6	17	3 and mirror	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:41
L9	7	3 and (resonator or resonat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:45

L10	6	(6 or 9) and (hermetic or hermetically or hermetic\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:46
L11	3	(6 and 9) and (hermetic or hermetically or hermetic\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:42
L12	3126	((si or silicon) and (ni or nickel)) near (cover or cover\$4 or coat or coat\$4 or layer or film) and (press or press\$4 or force or load) and (heat or heat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:43
L13	144	12 and ((si or silicon) near (ni or nickel)) near (cover or cover\$4 or coat or coat\$4 or layer or film)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:44
L14	2611	12 and (si or silicon or ni or nickel or cover or cover\$4 or coat or coat\$4 or layer or film) near (thick or thick\$5 or mm or millimeter or inch or microinch or inch\$3 or microinch\$3 or microm or micrometer or ".mu.m")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:44
L15	124	13 and 14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:44
L16	141	12 and (resonator or resonat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:45
L17	73	16 and mirror	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:45

L18	13	17 and bragg	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:45
L19	5	18 and (hermetic or hermetically or hermetic\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:46
L20	24	17 and (hermetic or hermetically or hermetic\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 08:46